

(0.635 mm) .025"

HDLSP-035-1000

HDLSP SERIES

HIGH-DENSITY/HIGH-SPEED CABLE SYSTEM

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?HDLSP

Cable:

32 AWG low skew pair cable

Insulator Material: LCP

Terminal Material: Phosphor Bronze

Jacket Material: PVC

Insulator: Dielectric

Conductors: Copper

Braid: Tinned Copper

Covers: Diecast Zinc Alloy

Current Rating: 1.5 A per pin (4 adjacent pins powered)

Mates with:

HD16

OTHER SOLUTIONS

For HT3.1 see www.samtec.com/ht3 and specify part number HDR-149112-XXXX.

Industry's densest I/O cable system

32 AWG low skew pair cable

Designed for heavy duty handling

12 pairs per side

48 pairs in 28 mm x 14 mm panel opening

ALSO AVAILABLE (MOQ Required)

- Other lengths

TYPE

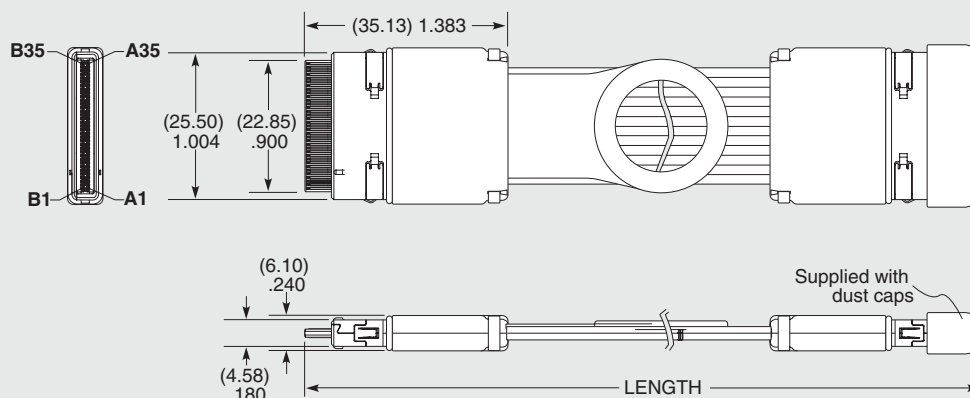
HDLSP
= High-density
Low Skew Pair Cable

NO. OF POSITIONS

-035
(Per Row)
= 12 Pairs per side

LENGTH

-“XXXX”
= Length in millimeters
-1000, -2000
(Standard lengths)



Note: Some lengths, styles and options are non-standard, non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM

All parts within this catalog are built to Samtec's specifications. Customer specific requirements must be approved by Samtec and identified in a Samtec customer-specific drawing to apply.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Samtec:](#)

[HDLSP-035-0120](#) [HDLSP-035-0150](#) [HDLSP-035-0153](#) [HDLSP-035-0200](#) [HDLSP-035-0250](#) [HDLSP-035-0300](#)
[HDLSP-035-1220](#) [HDLSP-035-1500](#) [HDLSP-035-2000](#) [HDLSP-035-0305](#) [HDLSP-035-0400](#) [HDLSP-035-0500](#)
[HDLSP-035-0600](#) [HDLSP-035-1000](#) [HDLSP-035-1219](#)